

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Eisai Co., Ltd.	06/04/2007
RECEIVING PARTY DATA	
Name:	Eisai R&D Management Co., Ltd.
Street Address:	6-10, Koishikawa 4-Chome, Bunkyo-ku,
City:	Tokyo
State/Country:	JAPAN
Postal Code:	112-8088
PROPERTY NUMBERS Total: 15	
Property Type	Number
Application Number:	10250693
Application Number:	11446416
Application Number:	10689088
Application Number:	10524662
Application Number:	10581591
Application Number:	10571285
Application Number:	11065631
Application Number:	10577065
Application Number:	10577531
Application Number:	10577042
Application Number:	10577308
Application Number:	11378315
Application Number:	11378307
Application Number:	10571279
Patent Number:	7091215

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CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	1056-0150M
NAME OF SUBMITTER:	John W. Bailey

Total Attachments: 3
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ASSIGNMENT

WHEREAS, Eisai Co., Ltd., a corporation organized and existing under and by virtue of the laws of Japan, having an office at 6-10, Koishikawa 4-Chome, Bunkyo-ku, Tokyo, Japan 112-8088, is the owner of the entire undivided right, title and interest in and to the following listed applications and U.S. patents in the United States by previous assignments:

U.S. Application No. 10/250,693	Filed on October 27, 2003
U.S. Application No. 11/446,416	Filed on June 5, 2006
U.S. Application No. 10/689,088	Filed on October 21, 2003
U.S. Application No. 10/524,662	Filed on December 13, 2005
U.S. Application No. 10/581,591	Filed on June 5, 2006
U.S. Application No. 10/571,285	Filed on March 9, 2006
U.S. Application No. 11/065,631	Filed on February 25, 2005
U.S. Application No. 10/577,065	Filed on April 24, 2006
U.S. Application No. 10/577,531	Filed on April 28, 2006
U.S. Application No. 10/577,042	Filed on April 24, 2006
U.S. Application No. 10/577,308	Filed on April 28, 2006
U.S. Application No. 11/378,315	Filed on March 20, 2006
U.S. Application No. 11/378,307	Filed on March 20, 2006
U.S. Application No. 10/571,279	Filed on March 9, 2006
U.S. Patent No. 7,091,215	Issued on August 15, 2006

WHEREAS, Eisai R&D Management Co., Ltd., a Division Corporation of Eisai Co., Ltd., organized and existing under and by virtue of the laws of Japan, having an office at 6-10, Koishikawa 4-Chome, Bunkyo-ku, Tokyo, Japan 112-8088, is desirous of acquiring the entire right, title and interest in and to the said applications and the inventions therein described and claimed and any Letters Patent that may be issued upon said applications or for the improvements therein contained;

NOW THEREFORE, for and in consideration of the sum of Ten Dollars (\$10.00) lawful money of the United States and other valuable considerations, to me in hand paid, the receipt of and sufficiency whereof are hereby acknowledged, the said Eisai Co., Ltd., on April 3, 2006, sold, assigned and transferred and does hereby sell, assign and transfer unto the said Eisai R&D Management Co., Ltd., its successors and assigns, its entire undivided right, title and interest in

and to the said applications and patents and the inventions therein contained, including all rights of action and damages for past infringement, and including the right to apply for any Letters Patent in the United States of America and in all foreign countries on said inventions and including the right to claim the priority of the date of filing in the United States and any Letters Patent that may issue thereon, or therefor, in the United States and foreign countries and all reissues, extensions, renewals, divisions and continuations thereof, to the full end of the term or terms for which said Letters Patent may be issued, to be held and enjoyed by the said Eisai R&D Management Co., Ltd., its successors and assigns the same as it would have been held and enjoyed by Eisai Co., Ltd., if this assignment and sale had not been made.

AND, Eisai Co., Ltd., hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all such Letters Patents to the said Eisai R&D Management Co., Ltd., in accordance with this instrument of assignment.

Eisai Co., Ltd., hereby represents and warrants that there are no rights or interests outstanding inconsistent with the rights and interests granted herein and that Eisai Co., Ltd., will not execute any instrument or grant or transfer any rights or interests inconsistent therewith, and Eisai Co., Ltd., binds itself and its heirs, executors, administrators, employees and legal representatives, as the case may be, to execute and deliver to the said Eisai R&D Management Co., Ltd., its successors and assigns, any further documents or instruments and do any and all further acts that may be deemed necessary by the said Eisai R&D Management Co., Ltd., its successors and assigns to file applications for the said improvements and invention in any country where it may elect to file such applications, and that may be necessary to vest in the said Eisai R&D Management Co., Ltd., its successors and assigns, the title herein conveyed, or intended so to be, and to enable such title to be recorded in the United States and foreign countries where such application or applications may be filed.

AND, Eisai Co., Ltd., further covenants and agrees, in consideration of the premises, that it, its executors and administrators will, at any time upon request, communicate to the said Eisai R&D Management Co., Ltd., its successors and assigns, any facts relating to the said invention and improvements and the history thereof, known to it or its successors and assigns, and that it

will testify as to the same in any interference or other proceeding when requested to do so by the said Eisai R&D Management Co., Ltd., its successors and assigns.

The undersigned hereby grants the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

IN TESTIMONY WHEREOF, Eisai Co., Ltd., has hereunto set its seal this 27 day of June, 2007

Eisai Co., Ltd.,

By: 

Mr. Nobuo DEGUCHI

Title: Senior Vice President, Intellectual Property